

APPROVAL SHEET

WLPN404018 Series Shielded SMD Power Inductors

*Contents in this sheet are subject to change without prior notice.



Features

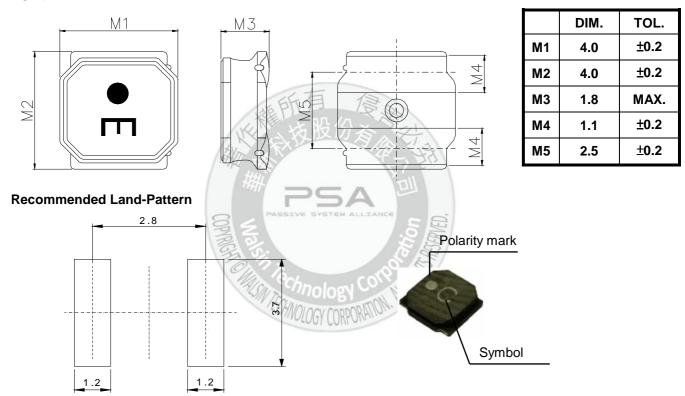
- 1. Close magnetic loop with magnetic resin shielded.
- 2. Low profile, High inductance.

Applications

- 1. General propose power inductor in DC power system.
- 2. Inductor in DC/DC converter.
- 3. Low profile for portable and wearable device.
- 4. LC filter in Audio D class Amplifier.

Shape and Dimension

Unit: mm



Ordering Information

WL	PN	4040	18	N	1R0	L	В	
Product Code	Series	Dimensions	Thickness	Tolerance	Value	Packing Code		
WL: Inductor	Shielded SMD Power Inductors	4.0 * 4.0 mm	1.8 mm	M: ± 20% N: ± 30%	1R0 = 1.0uH 100 = 10uH	L=13" Reeled (Embossed Tape)	B:STD	



Electrical Characteristics

WLPN404018	L	Symbol	Inductance	DCR	SRF	Rated Current (mA) Max		
Series	(uH)	Cymbol	Tolerance (Ω±200		(MHz)Min	Saturation Current Idc1	Temperature Rise Current Idc2	
WLPN404018N1R0LB	1.0	А	±30%	0.027	90	4000	3200	
WLPN404018N1R5LB	1.5	В	±30%	0.037	75	3300	2400	
WLPN404018M2R2LB	2.2	С	±20%	0.042	60	3000	2200	
WLPN404018M3R3LB	3.3	E	±20%	0.055	45	2300	2000	
WLPN404018M4R7LB	4.7	Н	±20%	0.070	35	2000	1700	
WLPN404018M6R8LB	6.8	I	±20%	0.098	30	1600	1450	
WLPN404018M100LB	10	K	±20%	0.150	25	1300	1200	
WLPN404018M150LB	15	М	±20%	0.210	18	1100	850	
WLPN404018M220LB	22	N	±20%	0.290	15	900	720	
WLPN404018M330LB	33	Р	±20%	0.460	12	700	550	
WLPN404018M470LB	47	S	±20%	0.650	10	600	440	
WLPN404018M680LB	68	TXX	±20%	1.000	8.3	520	320	
WLPN404018M101LB	100	Y	±20%	1.450	6.5	420	280	
WLPN404018M151LB	150	W	±20%	2.300	5.5	340	220	
WLPN404018M221LB	220	Х	±20%	3.800	4.0	275	170	

1. Test Frequency: 100KHz

2. Test Equipment:

Inductance: Chroma3302+1320 or equivalent.

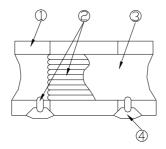
DCR: Chroma16502 or equivalent.

SRF: HP4291B or equivalent.

- 3. Saturation Current Idc1: The value of current causes a 30% inductance reduction from initial value.
- 4. Temperature rise current ldc2: The value of current causes a 40°C temperature rise.
- 5. Rated Current: Either Idc1 or Idc2 whichever is smaller.
- 6. Operating Temperature Range:-25°C to +125°C (Including self-temperature rise)
- 7. Storage Temp. Range : -40° C to $+85^{\circ}$ C.
- 8. MSL: Level 1



Structural Drawing



(Magnetic Shielded Type)

① Ferrite core : Ni-Zn ferrite

② Winding wire: Polyurethane-copper wire

③ Over-coating resin: Epoxy resin, containing ferrite powder

④ Electrode : External electrode (substrate)

Ag

External electrode (base plating)

Ni-Sn

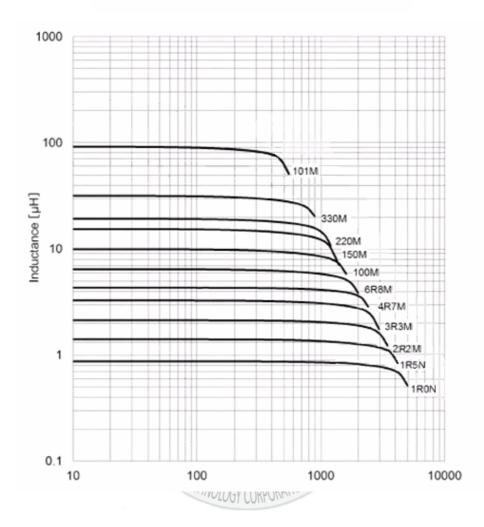
External electrode (top surface solder coating) Sn-Ag-Cu





Characteristic Curve



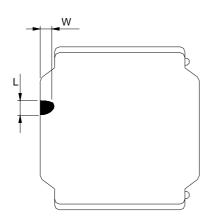


DC Current (mA)



Core Chipping:

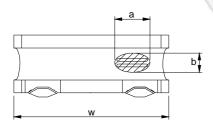
The appearance standard of the chipping size in top side, of bottom side ferrite Core is following dimension.



L	W
1.0mmMax.	1.0mmMax.



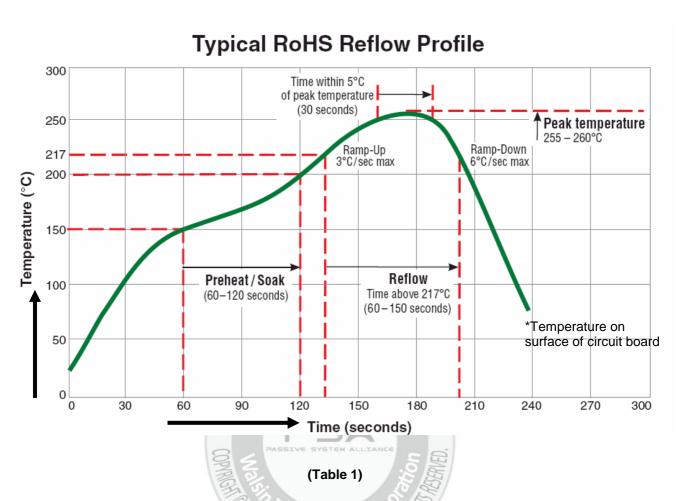
Exposed wire tolerance limit of coating resin part on product side Size of exposed wire occurring to coating resin is specified below.



- ① Width direction (dimension a): Acceptable when a<=w/2
 Nonconforming when a>w/2
- ② Length direction (dimension b): Dimension b is not specified.
- ③ When total area of exposed wire occurring to each sides is not greater than 50% of coating resin area, that is acceptable.



Reflow Profile Chart (Reference):



The products may be exposed to reflow soldering process of above profile up to two times.



Mechanical Performance /Environmental Test Performance Specifications: (WLPN404018 series)

No.	Item	Test condition	Requirements				
1	Resistance to Deflection	No damage.	The test samples shall be soldered to the test board by the reflow soldering conditions show in Table 1. As illustrated below, apply force in the direction of the Arrow indicating until deflection of the test board Reaches to 2 mm. Porce Rod Test Sample Land dimensions Unit: mm				
2	Adhesion of Terminal Electrode	Shall not come off PC board	Test board material I: glass epoxy-resin Solder cream thickness:0.1 The test samples shall be soldered to the test board By the reflow soldering conditions shown in Table 1. Applied force: 10 N to X and Y directions Duration: 5 s. Solder cream thickness:0.1 mm (Refer to recommended Land Pattern Dimensions Defined in "Precaution")				
3	Body strength	No damage	Applied force :20 N Duration :10 s R0.5mm Sample				
4	Resistance to Vibration	△L/L:within±10% No abnormality observed In appearance	The test samples shall be soldered to the test board by The reflow soldering conditions shown in Table 1.Then It shall be submitted to below test conditions Frequency range 10Hz~55Hz Total Amplitude 1.5mm(May not exceed acceleration 196 m/S2) Sweeping Method 10Hz to 55Hz to 10 Hz for 1 min. Time For 2 hours on each X, Y, and Z axis.				
5	Resistance to Soldering heat (Reflow)	△L/L:within±10% No abnormality observed In appearance	The test sample shall be exposed to reflow oven at 230±5 deg C for 40 seconds, with peak temperature at 260±5 deg C for 5 seconds, 2 times. Test board thickness:1.0 mm Test board material :glass epoxy-resin				



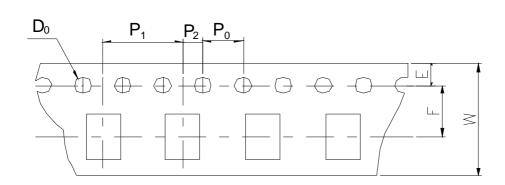
	Solder ability	At least 90% of		samples shall			then Immers	ed in
		surface of terminal electrode is	molten solder as shown in below table. Flux: Methanol solution containing rosin 25%					
6		covered by new	Solder Temperature Time			5±deg C		
6		solder.				±1.0 S.		
			Immersing Speed		25 mm/s		_	
			minicising opeca			7 11111/3		
7	Temperature Characteristics	△L/L:within±20% No abnormality observed In appearance	Range w With refe	Measurement of inductance shall be taken at ten Range within -25 deg C to +85 deg C. With reference to inductance value at +20 deg C Rate shall be calculated.			-	
	Thermal shock	△L/L:within±10% No abnormality observed In appearance	The test By the re The test Shown in The temp	ble 1.				
8			Condition	ns of steps for	1 cycle			
			Step	Tempera		Time(r	,	
			1	-40±3 de	eg C	30±	3	
			2	Room Te		3 maxir	mum	
			3	85±2 de		30±	3	
			4	Room Te		3 maxir		
9	Low Temperature life Test	△L/L:within±10% No abnormality observed In appearance	The reflo After that Condition Tem	samples shall w soldering co t, the test samples as shown in perature Time	nditions sh ples shall b below tabl -40±2	own in Table e placed at t	1.	
10	Loading at high temperature life test	△L/L:within±10% No abnormality observed in appearance.	The test samples shall be soldered to the test board by the reflow soldering conditions shown in Table 1. The test samples shall be placed in thermostatic oven set at specifit temperature and applied the rated current continuously as shown in below table. Temperature 85±2 deg C					t specified
			PHINIS	MITTAGE		current	-	
			Appl	ied current		o Page 3)		
				Time	500+	24/-0 h		
11	Damp heat life test	△L/L:within±10% No abnormality observed in appearance.	soldering The test temperat	samples shall g conditions sh samples shall cure and humid inperature	own in Tab be placed i lity as show 60±2 90~9	le 1. In thermostat <u>vn in below ta</u> deg C 15%RH	tic oven set a	
	Landing	A 1 /1 '11 ' 100'	Th - 4 ·	Time		24/-0 h	haandle d	nafla
12	Loading under Damp heat life test	△L/L:within±10% No abnormality observed in appearance.	soldering conditions shown in Table 1. The test samples shall be placed in therm temperature and humidity and applied the as shown in below table. Temperature 60±2 december 1.			le 1. n thermostat	tic oven set a d current cor	t specified
12						90~95%RH		
			-		Dete !			
			Applied current		Rated current (Refer to Page 3) 500+24/-0 h			
				Time		300+24/-U r	I	

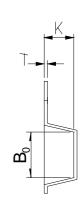


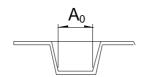
Tape & Reel Packaging Dimensions:

Dimensions

Unit: mm



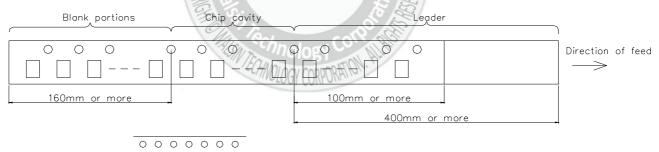




A_0	B ₀	W	F	EGG	有P1 g	P ₂	P ₀	D_0	Т	K
4.3 ±0.1	4.3 ±0.1	12.0 ±0.3	5.5 ±0.1	1.75 ±0.1	8.0 ±0.1	2.0 ±0.1	4.0 ±0.1	Φ1.5 +0.1 -0	0.3 ±0.05	2.1 ±0.1

Direction of rolling

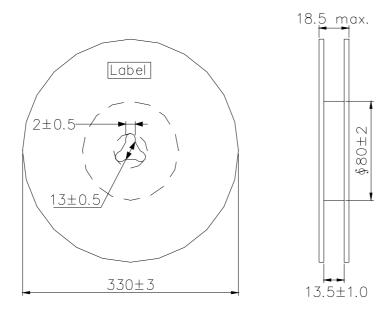
PASSIVE SYSTEM ALLIANCE

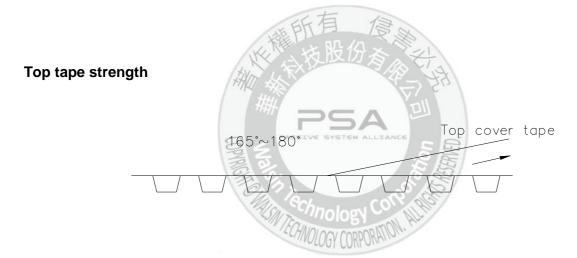


Direction of production insertion



Reel





Peel-off strength: 0.1N~1.3N Peel-off angle:165°~180° Peel-off speed: 300mm/mm

Quantity per reel: 3.5K pcs (3500 pcs)

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